宁波芮恒特电子有限公司 NINGBO RHT ELECTRONIC CO.,LTD

APPROVAL SHEET

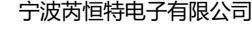


(Seam Type)

CUSTOMER:	
DESCRIPTION:	SMD3225 16.000MHz Quartz Crystal Resonator
MANUFACTURER PART NO.:	FTX16.000M12SM3S-20/20DFC47
CUSTOMER PART NO:	
USED IN MODEL:	
REVISION	A1

	承 认	APPROVAL
工程部	品质部	采购部
TECHNOLOGY DEPT.	QUALITY D	EPT. PURCHASING DEPT.

Date: April 14, 2022





NINGBO RHT ELECTRONIC CO.,LTD

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Rev	Revise page	Revise contents	<u>Date</u>	Ref.No.	Reviser
A1	ALL	Initial released		N/A	DavidJiang

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1. QUARTZ CRYSTAL UNIT SPECIFICATION

Parameter	Sign	Specification
1.1 Nominal Frequency :	F0	16.000MHz
1.2 Holder type :	-	FTX321S (SMD3225 SEAM TYPE)
1.3 Mode of oscillation :	-	Fundamental
1.4 Frequency tolerance :	FL	±20ppm at 25℃±3℃
1.5 Equivalent resistance :	RR	40ohms max.
1.6 Operating temperature range :	T _{OPR}	-20℃ To +70℃
1.7 Storage temperature range :	T _{STG}	-55℃ To +125℃
1.8 Frequency Stability :	TC	±20ppm at -20℃ To +70℃
1.9 Loading capacitance :	CL	12pF
1.10 Drive level :	DL	10 uW Typical, 100uW max.
1.11 Shunt Capacitance :	C0	2.0pF max.
1.12 Insulation resistance :	IR	More than $500 M\Omega$ at DC $100 V$
1.13 Circuit:	-	Measured in HP/E5100A,S&A 250B
1.14 Aging :	Fa	±2ppm max. (+25°C 1 st Year)
1.15 Dimensions and marking :		Refer to page.3
1.16 Emboss carrier tape & reel :		Refer to page.5 and page.6

Standard atmospheric conditions

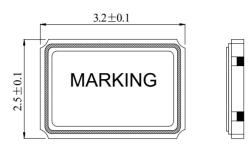
Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

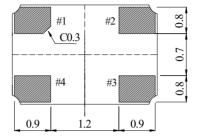
Ambient temperature : $25\pm3^{\circ}$ C Relative humidity : 40%~70%

1.17 Note:

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2. FTX321S MARKING & DIMENSIONS

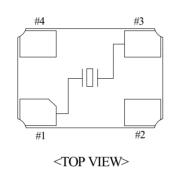


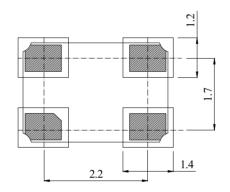




Marking #2, #4 is connected with metal cap of top.

(UNIT: mm)





Recommended Solder Pad Layout:

*Marking should be printed as following:

Logo, Nominal Frequency

*Manufacturing Logo: FT

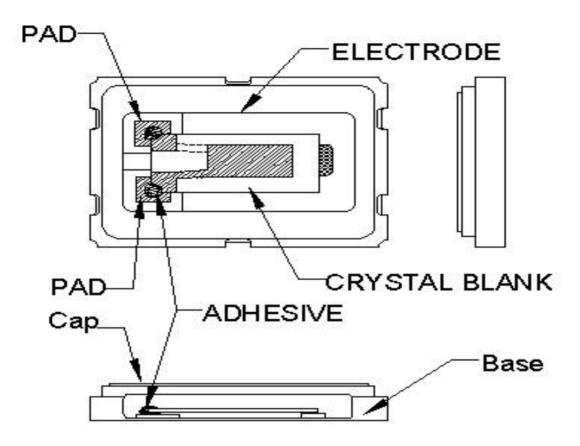
*Nominal frequency = 3 number after decimal point MAX.

(ex. $16.000 \text{ MHz} \rightarrow 16.000$)

Marking: Laser marking

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3. INSIDE STRUCTURE



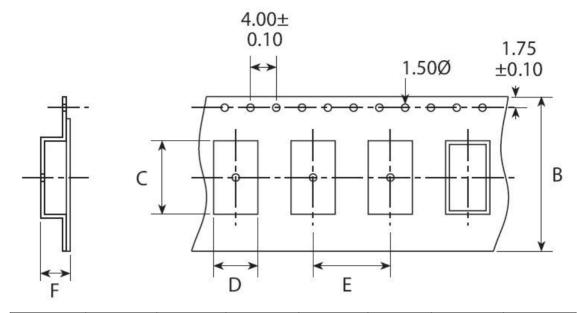
Reference drawing

Colorence drawing
Base:
Alumina Ceramic (Al ₂ O ₃)
Metallized Pad: W
Ni Plating
Au Plating
Cap:
Fe-Ni
(3) Crystal Enclosure Seal:
Seal Seam
(4) Crystal Blank
Rectangular At-Cut Quartz Crystal Blank
(5) Adhesive
Silver Conductive Polyimide Resin
(6) Electrode
Ag
(7) PAD
Alumina Ceramic (W. Ni. Au)

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4. FTX321S EMBOSS CARRIER TAPE & REEL

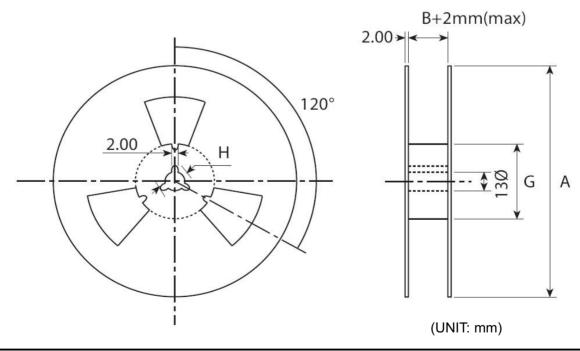
a.) Dimensions of Carrier Tape



	A	В	С	D	Е	F	G
SMD3225	178±2.0	8.0 ± 0.3	3.5±0.1	2.8 ± 0.1	4.0±0.1	1.4±0.1	60.5 ± 1.0

(UNIT: mm)

b.) Dimensions of Reel



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c.) Storage condition

Temperature: +40deg.C Max. Relative Humidity: 80% Max.

d.) Standard packing quantity

3,000PCS / REEL

e.) Material of the tape

Tape	Material
Carrier tape	A – PET
Top tape	Polyester

- f.) Label contents
 - .The type of product
 - .Our specification No.
 - .Your Part No.
 - .Lot No.
 - .Nominal Frequency
 - .Quantity
 - .Our Company Name

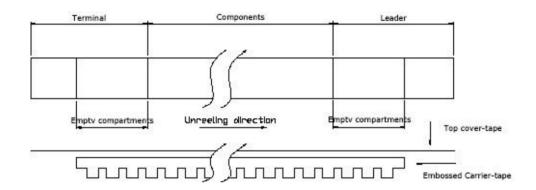
Sticks label for every reel.

PART NUMBER		
PO NO		
PR. NO:		
HOLDER TYPE		
FREQUENCY		
REMAKS		
QUANTITY		
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g.) Taping dimension

Leader	Cover-tape	The length of cover-tape in the leader is more than 400 mm including empty embossed area.
Leader	Carrier-tape After all products were packaged, must remain more than twenty piece 400 mm empty area, which should be sealed by cover-tape.	
	Cover-tape	The tip of cover-tape shall be fixed temporary by paper tape and roll around the core of reel one round.
Terminal	Carrier-tape	The empty embossed area which are sealed by top cover-tape must remain more the 40 mm.



h.) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

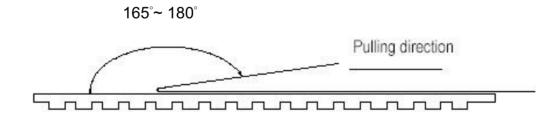
i.) Release strength of cover tape

It has to between 0.1N to 0.7N under following condition.

Pulling direction 165° to 180°

Speed 300mm/min.

Otherwise unless specified.

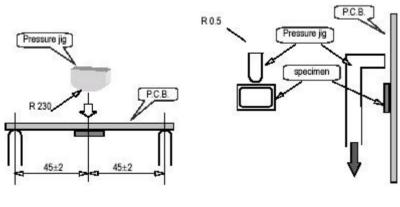


Other standards shall be based on JIS C 0806-1990.

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5. Mechanical Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

	Item	Conditions	Specifications
5.1	Drop	Fall freely from 100 cm of height 3 times on a firm wood	MIL-STD-202F-203B
5.2	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutually perpendicular axes each 3 times.	MIL-STD-202F
5.3	Vibration	 (1)Vibration Frequency: 10~55Hz (2)Cycle: 1 to 2 Min. (3)Full Cycle: 1.5mm P-P. (4)Direction: X.Y.Z (5)Time: 2 Hours / Each Direction 	MIL-STD-883E
5.4	Substrate Bending	Mount the specimen on substrate. Apply the following pressure Direction: see Fig –1 Speed: 0.5 mm/sec Hours: 5 ± 1 sec Amount of substrate: 3 mm Max.	Without mechanical
5.5	Adhesion	Mount the specimen on substrate. Apply the following pressure Direction: see Fig –2 Weight: 10N Hours: 10 ± 1 sec	damage such as breaks. Without electrode peeling. Electrical characteristics shall be satisfied.
5.6	Body strength	Mount the specimen on substrate. Apply the following pressure Direction: see Fig –3 Weight: 10N Hours: 10 ± 1 sec	
5.7	Seal	Fine Leak: 4.5kgf/cm ² 2hours 1×10 ⁻⁹ Pa.m ³ /sec Gross Leak: 4.5kgf/cm ² 2hours 1.5×10 ⁻⁵ Pa.m ³ /sec	MIL-STD-883E



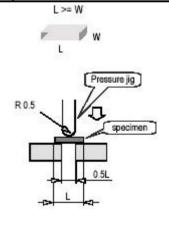


Fig-1	Fig-2	Fig-3
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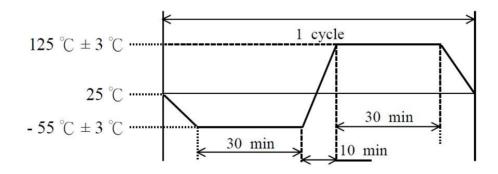
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5.8	Solder ability	Pre-heat temperature: +150±10°C Pre-heat time: 60~120s When the temperature of the specimen is reached at +215±3°C, it shall be left for 30±1sec. Peak temperature 240±5°C Material: Pb-free (Sn-3.0Ag-0.5Cu) Flux: Rosin resin methyl alcohol solvent (1:4) The electrodes should be covered by a new solder at least 90% of immersed area.	MIL-STD-883E 2003
5.9	Resistance to Soldering Heat	Run in Reflow Reflow soldering shall be allowed Only two(2) time. Available for Lead Free Soldering PEAK 260±5 °C 10s PEAK 260±5 °C 10s TIME (Seconds) Total: (1) Preheat 160~180 deg.C 120sec. (2) Primary heat 220 deg.C 60sec. (3) Peak 260 deg.C 10sec. Max.	MIL-STD-202F

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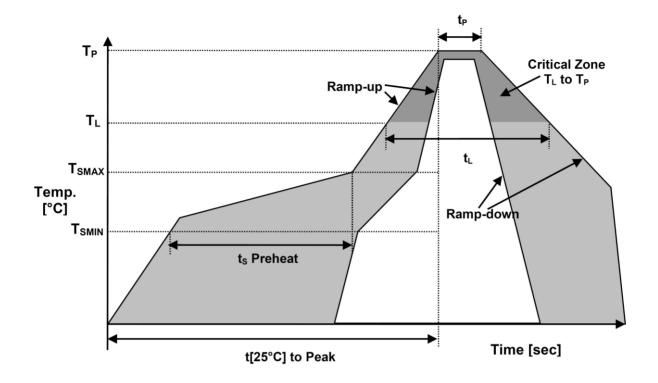
6. Environmental Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

	Item	Conditions	Specifications
6.1	Humidity	+60℃±2℃,RH 80~85%, Duration of 500 hours. The units are then allowed to stand for approx 2 hours in room temperature before checking	MIL-STD-202F
6.2	Storage in Low Temperature	Temperature: -40±2°C , Duration of 500 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	MIL-STD-883E
6.3	Temperature:+85°C±2°C, Storage in High Temperature The units are then allowed to stand at room temperature for approx 2 hours before checking.		MIL-STD-883E
6.4	Thermal Shock	Temperature 1: -55°C±5°C Temperature 2: 125°C±5°C Temperature change between T1 and T2 at soonest Run 100 cycles, maintain T1 and T2 30minutes each in one cycle (Refer to Fig-4)	MIL-STD-883E



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7. Recommended Solder Reflow Profile



Temperature Min Preheat	T _{SMIN}	150℃
Temperature Max Preheat	T _{SMAX}	175℃
Time (T _{SMIN} to T _{SMAX})	ts	60-180 sec.
Temperature	TL	217℃
Peak Temperature	T _P	260℃
Ramp-up rate	Rup	3°C/sec max.
Ramp-down rate	R _{DOWN}	6°C/sec max.
Time within 5°C of Peak Temperature	t _P	10 sec max.
Time t[25°C] to Peak Temperature	t[25°C] to Peak	480 sec max.
Time	tL	60-150 sec.

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